

WHAT IS CLAIMED IS:

1. A circuit board having circuit patterns printed on its opposite sides, the substrate of which circuit board has a circuit pattern printed on each side, an
5 anti-soldering layer lying on the circuit pattern to prevent soldering material from sticking to the circuit pattern and at least one silk-screen printing area lying on the anti-soldering layer to indicate where a selected electric or electronic part or device is to be mounted, the silk-screen printing area having at least one terminal hole made at its center, characterized in that the board has a substrate-exposed zone
10 traversing the silk-screen printing area, and that the terminal hole has a conductor layer formed on its inner circumference.
2. A circuit board according to claim 1, wherein the conductor layer is contiguous to the circuit pattern.
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3. A soldering structure for a circuit board having circuit patterns printed on its opposite sides, the substrate of which circuit board has a circuit pattern printed on each side, an anti-soldering layer lying on the circuit pattern to prevent soldering material from sticking to the circuit pattern and at least one silk-screen printing area
20 lying on the anti-soldering layer to indicate where a selected electric or electronic part or device is to be mounted, the silk-screen printing area having at least one terminal hole made at its center, characterized in that the board has a substrate-exposed zone traversing the silk-screen printing area, thereby forming a space between the exposed substrate surface and the bottom of the electric or
25 electronic part, which is laid on the silk-screen printing area with its terminal lead or leads passing through the terminal hole or holes, each terminal hole having a conductor layer formed on its inner circumference, the annular space defined by the terminal lead and the surrounding conductor layer in the terminal hole being filled with soldering material.

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